502161189 12/13/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
Zhen-Yu Li	10/16/2012
Hon-Way lin	10/16/2012
Chung-Pao Lin	10/16/2012
Hsing-Kuo Hsia	10/16/2012
Hao-Chung Kuo	10/16/2012

RECEIVING PARTY DATA

Name:	TSMC Solid State Lighting Ltd.	
Street Address:	9, Li-Hsin 4th Rd.	
Internal Address:	HsinChu Science Park	
City:	HsinChu	
State/Country:	TAIWAN	
Postal Code:	300-77	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13616299

CORRESPONDENCE DATA

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Address Line 2: Suite 700

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ATTORNEY DOCKET NUMBER: 48047.131/20012-0719

PATENT

REEL: 029460 FRAME: 0136

P \$40,00 13616299

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NAME OF SUBMITTER:	David M. O'Dell	
Total Attachments: 3 source=48047-131Assignment#page1.tif source=48047-131Assignment#page2.tif source=48047-131Assignment#page3.tif		

PATENT REEL: 029460 FRAME: 0137

Docket No.: 2012-0719 / 48047.131

Customer No.: 42717

ASSIGNMENT

WHEREAS,	we.

(1)	Zhen-Yu Li	of	No. 19, Zuntoukeng, Zhuqi Township Chiayi County 604, Taiwan, R.O.C.
(2)	Hon-Way Lin	of	13F-5, No. 123, Puding 2 nd Rd., East Dist. Hsinchu City 300, Taiwan, R.O.C.
(3)	Chung-Pao Lin	of	No. 26, Ln. 1, Wuhua Street, Sanchong Dist. New Taipei City 241, Taiwan, R.O.C.
(4)	Hsing-Kuo Hsia	of	F7, No. 13 Fu-Hsin 6 th Road, Jhubei City Hsin Chu County, Taiwan, R.O.C.
(5)	Hao-Chung Kuo	of	3F, No. 135, Fuxing 1 st Street, Tsu-bai City Hsin-Tsu County 302, Taiwan, R.O.C.

have invented certain improvements in

III-V GROUP COMPOUND DEVICES WITH IMPROVED EFFICIENCY AND DROOP RATE

for which we have filed and executed an application for Letters Patent of the United States of America on 09-14-2012, as U.S. Serial No. 13/616,299; and

WHEREAS, TSMC Solid State Lighting Ltd., 9, Li-Hsin 4th Rd., HsinChu Science Park, HsinChu, Taiwan, ROC. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC Solid State Lighting Ltd., its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC Solid State Lighting Ltd., its successors, legal representatives and assigns, in accordance with the terms of this instrument.

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AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC Solid State Lighting Ltd., its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC Solid State Lighting Ltd., its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor	Name:
mvemor	rvaine:

Zhen-Yu Li

Residence Address:

No. 19, Zuntoukeng, Zhuqi Township

Chiayi County 604, Taiwan, R.O.C.

√				
Dated:	10-	16	-2012	1.

When-Yu Li Inventor Signature

Inventor Name:

Hon-Way Lin

Residence Address:

13F-5, No. 1213, Puding 2nd Rd., East Dist.

Hsinchu City 300, Taiwan, R.O.C.

Dated: 10-16-2012

Inventor Signature

Inventor Name:

Chung-Pao Lin

Residence Address:

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Dated: 10-16-2012

Churg - Pao Lin
Inventor Signature

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Inventor Name:

Hsing-Kuo Hsia

Residence Address:

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V 10/16/2012

Inventor Name:

Hao-Chung Kuo

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Hsin-Tsu County 302, Taiwan, R.O.C.

Dated: 10-16-20/2

RECORDED: 12/13/2012